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SIR:

Please address all future correspondence concerning the above application
or any patent to issue to the following:

William H. Dippert
Reed Smith LLP
599 Lexington Avenue
29th Floor
New York, New York 10022
(212) 521-5400

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Customer No. 026418

Respectfully submitted,

William H. Dippert
William H. Dippert
Reg. No. 26,723